## **BAS70-04LT1G, SBAS70-04LT1G**

# **Dual Series Schottky Barrier Diode**

These Schottky barrier diodes are designed for high speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand held and portable applications where space is limited.

#### **Features**

- Extremely Fast Switching Speed
- Low Forward Voltage
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable

## MAXIMUM RATINGS (T<sub>J</sub> = 150°C unless otherwise noted)

Rating	Symbol	Value	Unit
Reverse Voltage	V <sub>R</sub>	70	V
Non-Repetitive Peak Forward Surge Current (t ≤ 1.0 s)	I <sub>FSM</sub>	100	mA

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Forward Power Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>F</sub>	225 1.8	mW mW/°C
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	–55 to +150	°C
Thermal Resistance Junction-to-Ambient	$R_{ hetaJA}$	508 (Note 1) 311 (Note 2)	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

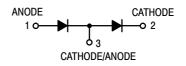
- 1. FR-4 @ minimum pad.
- 2. FR-4 @ 1.0 x 1.0 in pad.



## ON Semiconductor®

http://onsemi.com

## 70 VOLTS SCHOTTKY BARRIER DIODE





SOT-23 (TO-236AB) CASE 318

### **MARKING DIAGRAM**



CG = Specific Device Code

M = Date Code\*= Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or overbar may vary depending upon manufacturing location.

## ORDERING INFORMATION

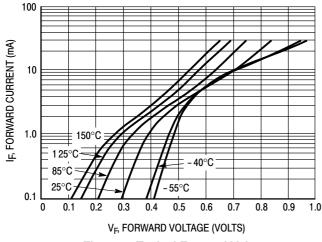
Device	Package	Shipping <sup>†</sup>
BAS70-04LT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel
SBAS70-04LT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

## **BAS70-04LT1G, SBAS70-04LT1G**

## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
Reverse Breakdown Voltage (I <sub>R</sub> = 10 μA)	V <sub>(BR)R</sub>	70	-	V
Total Capacitance (V <sub>R</sub> = 0 V, f = 1.0 MHz)	C <sub>T</sub>	-	2.0	pF
Reverse Leakage (V <sub>R</sub> = 50 V) (V <sub>R</sub> = 70 V)	I <sub>R</sub>	- -	0.1 10	μА
Forward Voltage (I <sub>F</sub> = 1.0 mA)	V <sub>F</sub>	-	410	mV
Forward Voltage (I <sub>F</sub> = 10 mA)	V <sub>F</sub>	-	750	mV
Forward Voltage (I <sub>F</sub> = 15 mA)	V <sub>F</sub>	-	1.0	V



100 T<sub>A</sub> = 150°C 125°C 125°C 0.01 0.01 0 5.0 10 15 20 25 30 35 40 45 50 V<sub>R</sub>, REVERSE VOLTAGE (VOLTS)

Figure 1. Typical Forward Voltage

Figure 2. Reverse Current versus Reverse Voltage

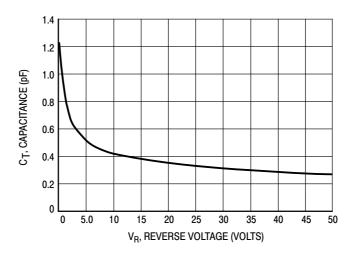
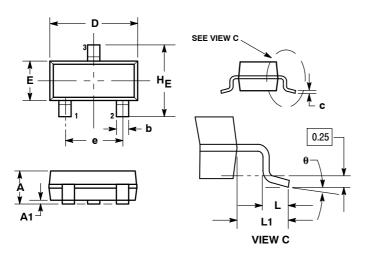


Figure 3. Typical Capacitance

## BAS70-04LT1G, SBAS70-04LT1G

#### PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AN** 



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
  MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF
- 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08

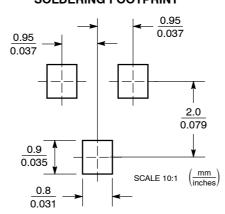
	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
С	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.40	2.64	0.083	0.094	0.104

#### STYLE 8:

## PIN 1. ANODE 2. NO CON

- NO CONNECTION
- CATHODE

## **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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